### STL6N2VH5



# N-channel 20 V, 0.025 Ω typ., 6 A STripFET™ V Power MOSFET in a PowerFLAT™ 2x2 package

Datasheet — production data

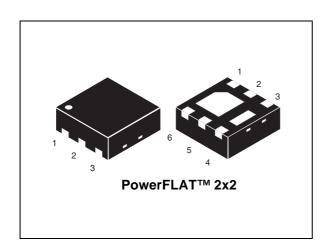
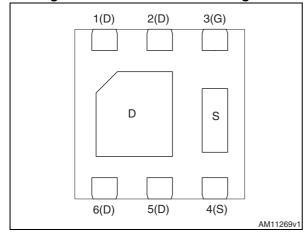


Figure 1. Internal schematic diagram



#### **Features**

Order code	V <sub>DS</sub>	R <sub>DS(on)</sub> max.	I <sub>D</sub>	P <sub>TOT</sub>
STL6N2VH5	20.1/	0.03 Ω (V <sub>GS</sub> =4.5 V)	6 A	2.4 W
STLUNZVID	20 V	0.04 Ω (V <sub>GS</sub> =2.5 V)	δА	∠.4 VV

- Very low switching gate charge
- Very low thermal resistance
- · Conduction losses reduced
- Switching losses reduced
- 2.5 V gate drive
- Very low threshold device

#### **Applications**

• Switching applications

## **Description**

This device is an N-channel Power MOSFET developed using STMicroelectronics' STripFET™V technology. The device has been optimized to achieve very low on-state resistance, contributing to a FOM that is among the best in its class.

Table 1. Device summary

Order cod	le Markin	g Packages	Packaging
STL6N2VI	d5 STD1	PowerFLAT™ 2	2x2 Tape and reel

Contents STL6N2VH5

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STL6N2VH5 Electrical ratings

# 1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V <sub>DS</sub>	Drain-source voltage	20	V
V <sub>GS</sub>	Gate-source voltage	± 8	٧
I <sub>D</sub> <sup>(1)</sup>	Drain current (continuous) at T <sub>pcb</sub> = 25 °C	6	Α
I <sub>D</sub> <sup>(1)</sup>	Drain current (continuous) at T <sub>pcb</sub> = 100 °C	3.75	Α
I <sub>DM</sub> (1),(2)	Drain current (pulsed)	24	Α
P <sub>TOT</sub> (1)	Total dissipation at T <sub>pcb</sub> = 25 °C	2.4	W
TJ	Operating junction temperature	-55 to 150	
T <sub>stg</sub>	Storage temperature	-55 to 150	ů

<sup>1.</sup> The value is rated according  $R_{\mbox{\scriptsize thj-pcb}}$ 

Table 3. Thermal resistance

Symbol	Parameter	Value	Unit
R <sub>thj-pcb</sub> (1)	Thermal resistance junction-pcb	52	°C/W

<sup>1.</sup> When mounted on FR-4 board of 1inch², 2oz Cu, t < 10 sec

<sup>2.</sup> Pulse width limited by safe operating area.

Electrical characteristics STL6N2VH5

# 2 Electrical characteristics

(T<sub>CASE</sub> = 25 °C unless otherwise specified)

Table 4. On/off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	$I_D = 250 \mu\text{A},  V_{GS} = 0$	20			V
1	Zero gate voltage drain	V <sub>DS</sub> = 20 V,			1	μΑ
DSS	current (V <sub>GS</sub> = 0)	V <sub>DS</sub> = 20 V, T <sub>J</sub> = 125 °C			10	μΑ
I <sub>GSS</sub>	Gate body leakage current (V <sub>DS</sub> = 0)	V <sub>GS</sub> = ±8 V			±100	nA
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu\text{A}$	0.7			V
B	Static drain-source on-	$V_{GS} = 4.5 \text{ V}, I_D = 3 \text{ A}$		0.025	0.03	Ω
R <sub>DS(on)</sub>	resistance	$V_{GS} = 2.5 \text{ V}, I_D = 3 \text{ A}$		0.031	0.04	Ω

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C <sub>iss</sub>	Input capacitance		-	367	-	pF
C <sub>oss</sub>	Output capacitance	V <sub>DS</sub> = 16 V, f=1 MHz,	-	92	-	pF
C <sub>rss</sub>	Reverse transfer capacitance	V <sub>GS</sub> =0	-	16	-	pF
Qg	Total gate charge	V <sub>DD</sub> = 10 V, I <sub>D</sub> = 2 A	-	4.6	-	nC
Q <sub>gs</sub>	Gate-source charge	V <sub>GS</sub> = 4.5 V	-	0.9	-	nC
Q <sub>gd</sub>	Gate-drain charge	(see Figure 14)	-	1	-	nC

Table 6. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub>	Turn-on delay time		-	4.8	-	ns
t <sub>r</sub>	Rise time	$V_{DD}$ = 10 V, $I_{D}$ = 2 A, $R_{G}$ = 4.7 $\Omega$ , $V_{GS}$ = 4.5 V	-	14.4	-	ns
t <sub>d(off)</sub>	Turn-off delay time	$G = 4.7 \Omega$ , $V_{GS} = 4.5 V$ (see Figure 13)	-	17	-	ns
t <sub>f</sub>	Fall time	,	-	4	-	ns

Table 7. Source drain diode

Symbol	Parameter	Test conditions	Min	Тур.	Max	Unit
I <sub>SD</sub>	Source-drain current		-		6	Α
I <sub>SDM</sub> <sup>(1)</sup>	Source-drain current (pulsed)		-		24	Α
V <sub>SD</sub> <sup>(2)</sup>	Forward on voltage	$I_{SD} = 2 A, V_{GS} = 0$	-		1.1	٧
t <sub>rr</sub>	Reverse recovery time I <sub>SD</sub> = 2 A,		-	10		ns
Q <sub>rr</sub>	Reverse recovery charge	$di/dt = 100 A/\mu s$ ,	-	24		nC
I <sub>RRM</sub>	Reverse recovery current	V <sub>DD</sub> = 16 V, T <sub>J</sub> = 150 °C	-	4.8		Α

<sup>1.</sup> Pulse width limited by safe operating area

<sup>2.</sup> Pulsed: pulse duration=300 $\mu$ s, duty cycle 1.5%

Electrical characteristics STL6N2VH5

#### 2.1 Electrical characteristics (curves)

Figure 2. Safe operating area

ID (A)

10

AM18126v1 K δ=0.

1ms

10ms

V<sub>D</sub>s(V)

AM18127v1 δ=0.5 10 0.02  $Z_{th} = k R_{thJ-pcb}$ -0.01 10<sup>-2</sup>  $\delta = t_p / \tau$ 10-10-4 10<sup>-3</sup> 10<sup>-2</sup> 10<sup>-1</sup> 10° tp(s) 10<sup>-5</sup>

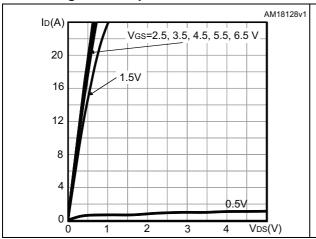
Figure 3. Thermal impedance

Figure 4. Output characteristics

Tj=150°C Tc=25°C Single pulse

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Figure 5. Transfer characteristics



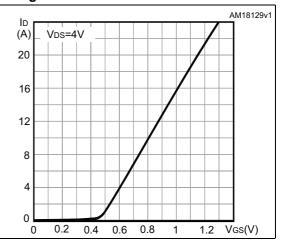
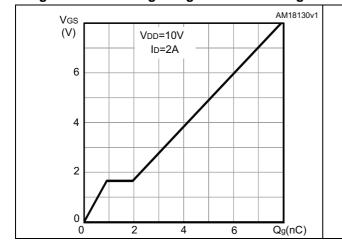
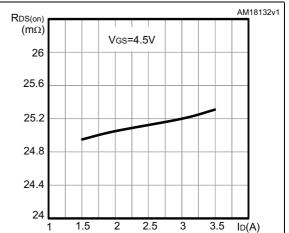


Figure 6. Gate charge vs gate-source voltage

Figure 7. Static drain-source on-resistance





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Figure 8. Capacitance variations

Figure 9. Normalized gate threshold voltage vs temperature

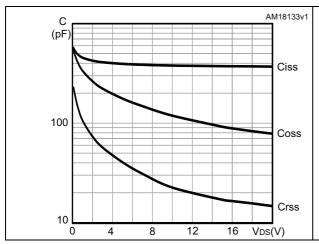
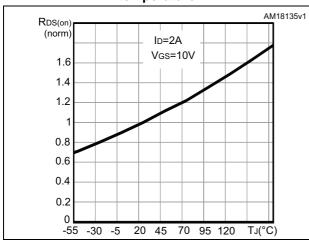


Figure 10. Normalized on-resistance vs temperature

Figure 11. Normalized  $V_{(BR)DSS}$  vs temperature



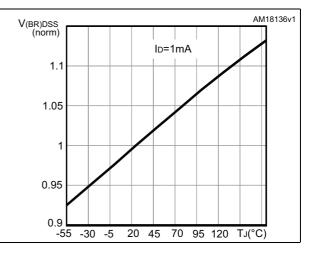
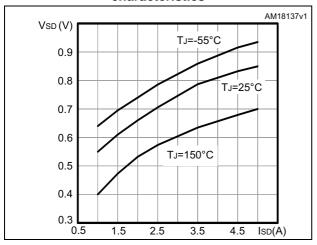


Figure 12. Source-drain diode forward characteristics



Test circuits STL6N2VH5

### 3 Test circuits

Figure 13. Switching times test circuit for resistive load

Figure 14. Gate charge test circuit

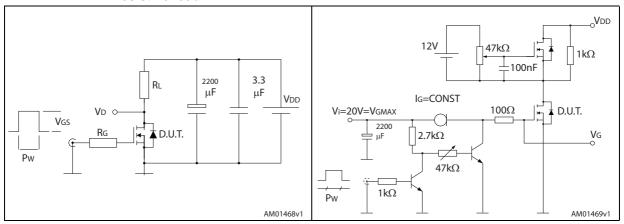


Figure 15. Test circuit for inductive load switching and diode recovery times

Figure 16. Unclamped inductive load test circuit

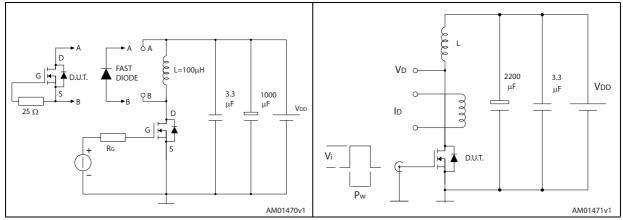
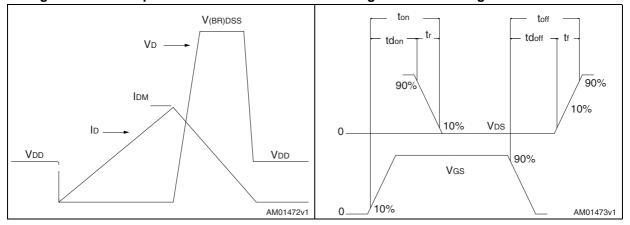


Figure 17. Unclamped inductive waveform

Figure 18. Switching time waveform



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# 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: <a href="https://www.st.com">www.st.com</a>. ECOPACK<sup>®</sup> is an ST trademark.



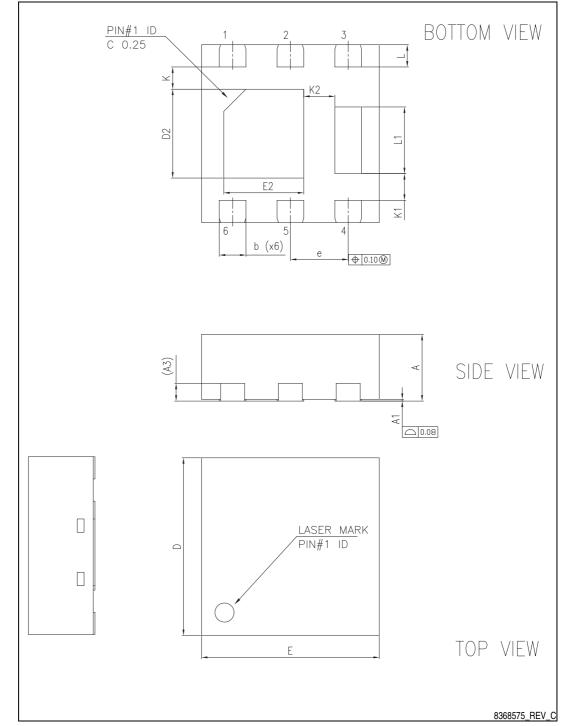


Figure 19. PowerFLAT™ 2 x 2 drawing

Table 8. PowerFLAT™ 2x2 mechanical data

Dim.		mm.	
Dilli.	Min.	Тур.	Max.
Α	0.70	0.75	0.80
A1	0.00	0.02	0.05
А3		0.20	
b	0.25	0.30	0.35
D	1.90	2.00	2.10
Е	1.90	2.00	2.10
D2	0.90	1.00	1.10
E2	0.80	0.90	1.00
е	0.55	0.65	0.75
K	0.15	0.25	0.35
K1	0.20	0.30	0.40
K2	0.25	0.35	0.45
L	0.20	0.25	0.30
L1	0.65	0.75	0.85



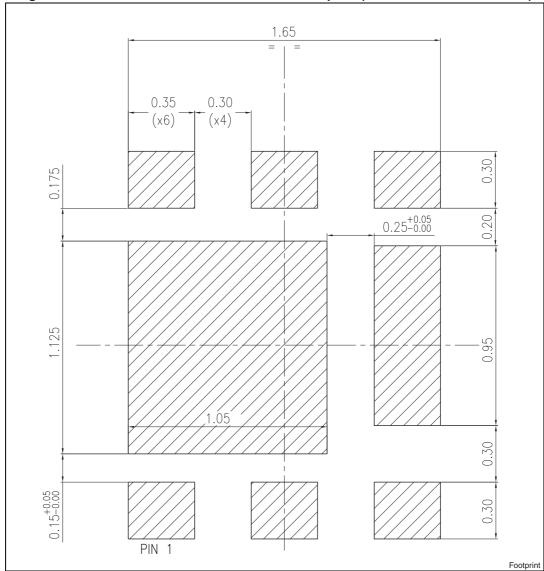


Figure 20. PowerFLAT™ 2 x 2 recommended footprint (dimensions in millimeters)

STL6N2VH5 Revision history

# 5 Revision history

**Table 9. Document revision history** 

Date	Revision	Changes
24-Apr-2012	1	First release.
10-Jan-2013	2	- Modified: R <sub>DS(on)</sub> values - Document status promoted from target data to preliminary data
19-Mar-2014	3	<ul> <li>Modified: the entire typical values in <i>Table 5</i>, 6 and 7</li> <li>Added: Section 2.1: Electrical characteristics (curves)</li> <li>Minor text changes</li> </ul>

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